Special Issue

Challenges and Future Trends of 3D Image Sensing, Visualization, and Processing: 2nd Edition

Message from the Guest Editor

The field of 3D image sensing, visualization, and processing has been thriving and growing in the last decade, by the increasing demand for accurate and efficient 3D sensing technologies across multiple industries, such as robotics, autonomous vehicles, and virtual reality, with remarkable progress despite facing many challenges and numerous future trends. Some of the key challenges include improving the accuracy, effectiveness and robustness of 3D sensing technologies. Near-future trends are moving towards the development of more advanced 3D sensors and the integration of 3D sensing into mobile devices and other consumer products. Machine and deep learning and artificial intelligence will play an increasingly important role in processing and analyzing 3D data, while virtual and augmented reality will become more prevalent in industries such as production, gaming, healthcare, and education. Potential topics include but are not limited to:

- 3D image sensing
- visualization
- processing
- machine learning
- deep learning
- artificial intelligence
- virtual reality
- augmented reality
- Industry 5.0
- healthcare

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Message from the Editor-in-Chief

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